TIBPAL 16L8-15C, TIBPAL 16R4-15C, TIBPAL 16R6-15C, TIBPAL 16R8-15C TIBPAL 16L8-20M, TIBPAL 16R4-20M, TIBPAL 16R6-20M, TIBPAL 16R8-20M HIGH-PERFORMANCE IMPACT™ PAL® CIRCUITS

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High-Performance Operation: Propagation Delay

> C Suffix . . . 15 ns Max M Suffix . . . 20 ns Max

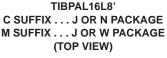
- Functionally Equivalent, but Faster Than PAL16L8A, PAL16R4A, PAL16R6A, and PAL16R8A
- Power-Up Clear on Registered Devices (All Register Outputs Are Set High, but Voltage Levels at the Output Pins Go Low)
- Package Options Include Both Plastic and **Ceramic Chip Carriers in Addition to Plastic and Ceramic DIPs**
- **Dependable Texas Instruments Quality and** Reliability

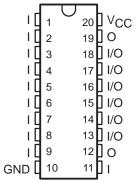
DEVICE	I INPUTS	3-STATE O OUTPUTS	REGISTERED Q OUTPUTS	I/O PORTS
PAL16L8	10	2	0	6
PAL16R4	8	0	4 (3-state buffers)	4
PAL16R6	8	0	6 (3-state buffers)	2
PAL16R8	8	0	8 (3-state buffers)	0

description

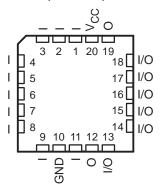
These programmable array logic devices feature high speed and functional equivalency when compared with currently available devices. These IMPACT™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allows for quick design of custom functions and typically results in a more compact circuit board. In addition, chip carriers are available for further reduction in board space.

The TIBPAL16' C series is characterized from 0°C to 75°C. The TIBPAL16' M series is characterized for operation over the full military temperature range of -55°C to 125°C.





TIBPAL16L8' C SUFFIX . . . FN PACKAGE M SUFFIX . . . FK PACKAGE (TOP VIEW)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

These devices are covered by U.S. Patent 4,410,987. IMPACT is a trademark of Texas Instruments. PAL is a registered trademark of Advanced Micro Devices Inc.

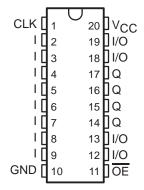


STRUMENTS

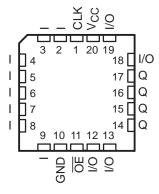
TIBPAL 16R4-15C, TIBPAL 16R6-15C, TIBPAL 16R8-15C TIBPAL 16R4-20M, TIBPAL 16R6-20M, TIBPAL 16R8-20M HIGH-PERFORMANCE *IMPACT* ™ *PAL*® CIRCUITS

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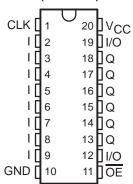
TIBPAL16R4'
C SUFFIX ... J OR N PACKAGE
M SUFFIX ... J OR W PACKAGE
(TOP VIEW)



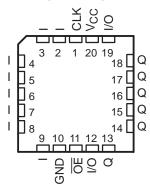
TIBPAL16R4'
C SUFFIX ... FN PACKAGE
M SUFFIX ... FK PACKAGE
(TOP VIEW)



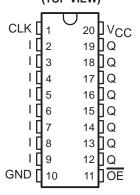
TIBPAL16R6'
C SUFFIX . . . J OR N PACKAGE
M SUFFIX . . . J OR W PACKAGE
(TOP VIEW)



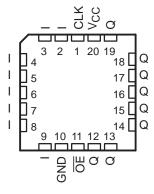
TIBPAL16R6'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE
(TOP VIEW)



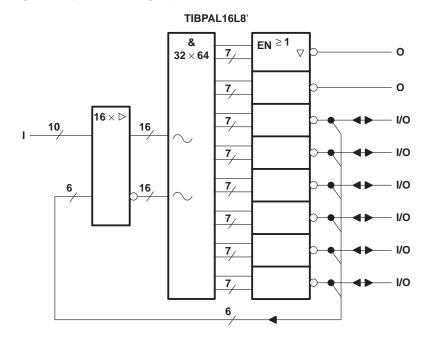
TIBPAL16R8'
C SUFFIX . . . J OR N PACKAGE
M SUFFIX . . . J OR W PACKAGE
(TOP VIEW)

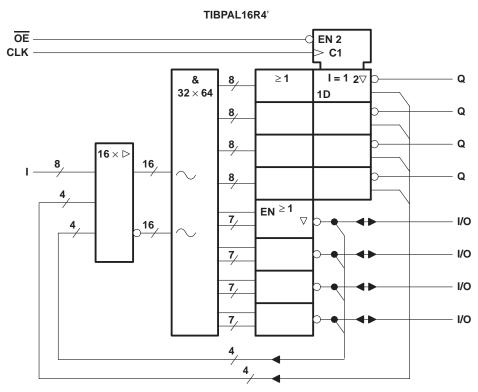


TIBPAL16R8'
C SUFFIX . . . FN PACKAGE
M SUFFIX . . . FK PACKAGE
(TOP VIEW)



functional block diagrams (positive logic)



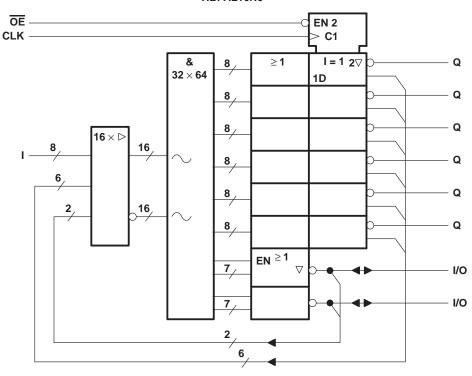


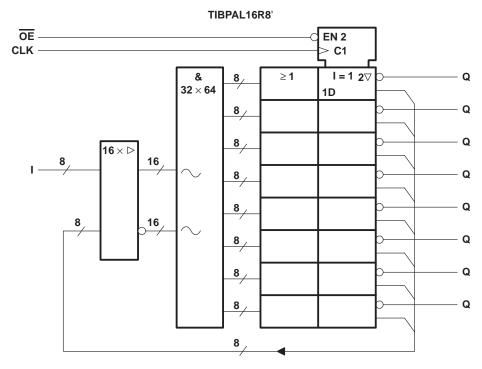
occupied denotes fused inputs



functional block diagrams (positive logic)

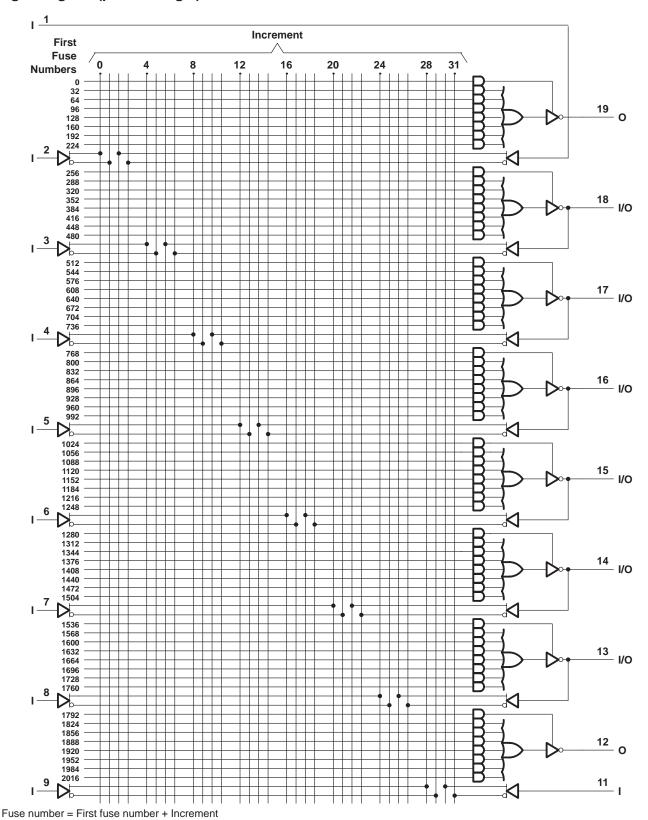
TIBPAL16R6'



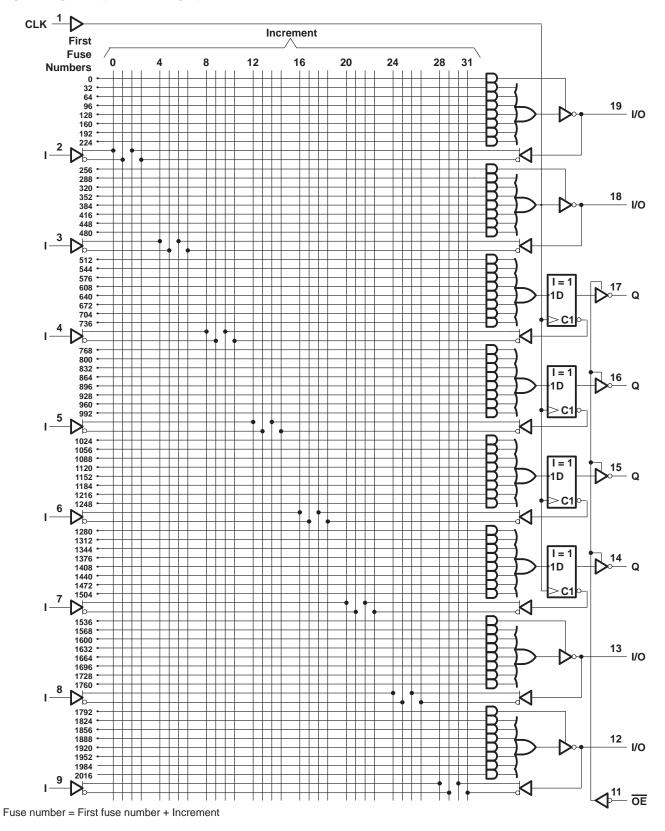


outputs denotes fused inputs

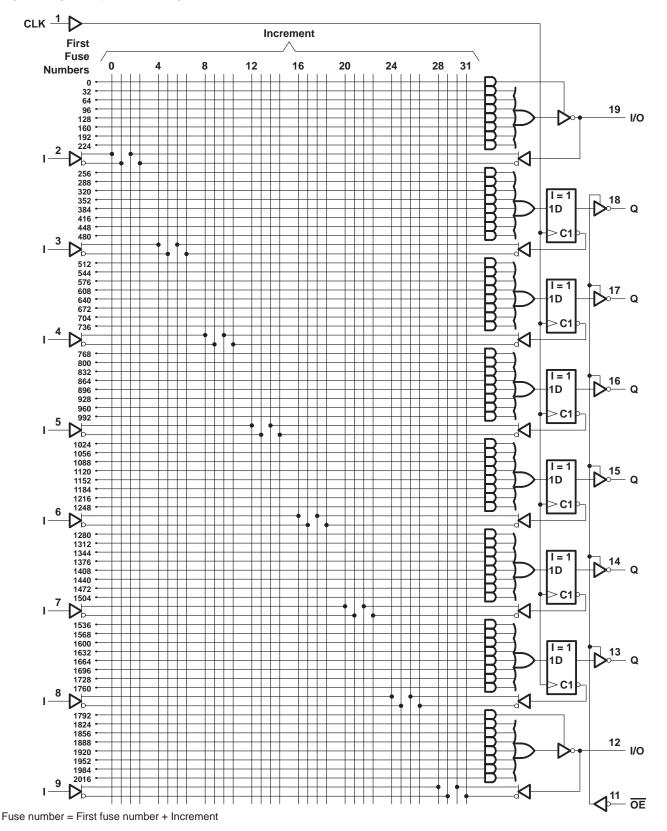




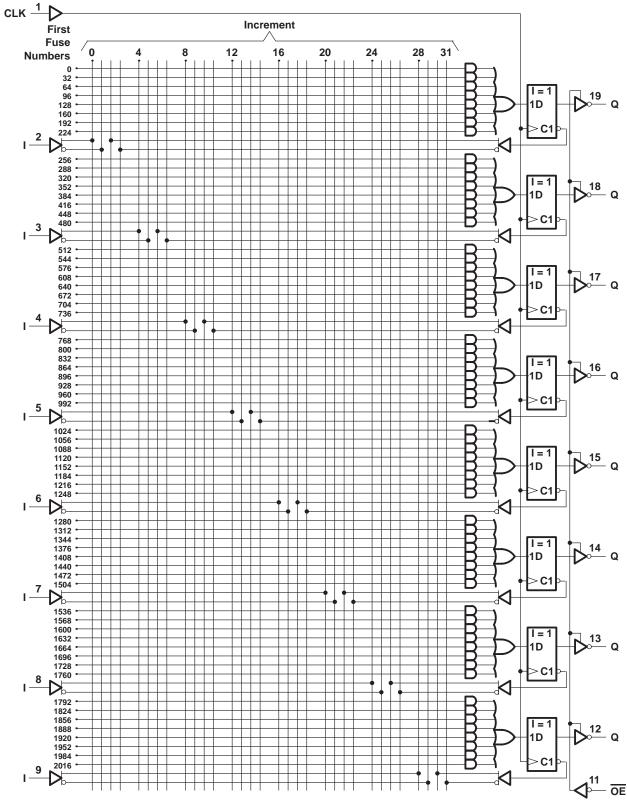
















TIBPAL 16L8-15C, TIBPAL 16R4-15C, TIBPAL 16R6-15C, TIBPAL 16R8-15C HIGH-PERFORMANCE IMPACT™ PAL® CIRCUITS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	0°C to 75°C
Storage temperature range, T _{stq} 65	5°C to 150°C

NOTE 1: These ratings apply, except for programming pins, during a programming cycle.

recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.75	5	5.25	V
VIH	High-level input voltage		2		5.5	V
VIL	Low-level input voltage				0.8	V
IOH High-level output current					-3.2	mA
loL	Low-level output current				24	mA
fclock	Clock frequency		0		50	MHz
	Pulse duration, clock (see Note 2)	High	8			no
t _W	ruise duration, clock (see Note 2)	Low	9			ns
t _{su}	Setup time, input or feedback before clock↑		15			ns
th	Hold time, input or feedback after clock↑		0			ns
TA	Operating free-air temperature		0	25	75	°C

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{Clock}. The minimum pulse durations specified are for clock high or low only, but not for both simultaneously.



TIBPAL 16L8-15C, TIBPAL 16R4-15C, TIBPAL 16R6-15C, TIBPAL 16R8-15C HIGH-PERFORMANCE $IMPACT \stackrel{\text{\tiny TM}}{=} PAL \stackrel{\text{\tiny R}}{=} CIRCUITS$

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electrical characteristics over recommended operating free-air temperature range

Р	ARAMETER		TEST CONDITIONS			TYP	MAX	UNIT
VIK		$V_{CC} = 4.75 \text{ V},$	$I_{I} = -18 \text{ mA}$				-1.5	V
Vон		$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -3.2 \text{ mA}$		2.4	3.3		V
VOL		$V_{CC} = 4.75 \text{ V},$	$I_{OL} = 24 \text{ mA}$			0.35	0.5	V
10=11	Outputs	V _{CC} = 5.25 V,	V _O = 2.7 V				20	
lozh	I/O ports	vCC = 5.25 v,	VO = 2.7 V				100	μΑ
1	Outputs	V-0 5 05 V	V- 0.4 V				-20	
lozL	I/O ports	V _{CC} = 5.25 V,	$V_0 = 0.4 \text{ V}$				-250	μΑ
II		V _{CC} = 5.25 V,	V _I = 5.5 V				0.1	mA
lн		V _{CC} = 5.25 V,	V _I = 2.7 V				20	μΑ
Ι _Ι L		$V_{CC} = 5.25 \text{ V},$	V _I = 0.4 V				-0.2	mA
I _O ‡		V _{CC} = 5.25 V,	V _O = 2.25 V		-30		-125	mA
Icc		V _{CC} = 5.25 V,	V _I = 0,	Outputs open		140	180	mA

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
f _{max}				50			MHz
^t pd	I, I/O	O, I/O			10	15	ns
^t pd	CLK↑	Q	R1 = 500Ω ,		8	12	ns
t _{en}	OE↓	Q	$R2 = 500 \Omega$,		8	12	ns
^t dis	OE↑	Q	See Figure 3		7	10	ns
t _{en}	I, I/O	O, I/O			10	15	ns
^t dis	I, I/O	O, I/O			10	15	ns

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ The output conditions have been chosen to produce a current that closely approximates one-half of the short-circuit output current, I_{OS}.

TIBPAL 16L8-20M, TIBPAL 16R4-20M, TIBPAL 16R6-20M, TIBPAL 16R8-20M HIGH-PERFORMANCE IMPACT ™ PAL® CIRCUITS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	-55°C to 125°C
Storage temperature range, T _{stq}	–65°C to 150°C

NOTE 1: These ratings apply, except for programming pins, during a programming cycle.

recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	V
VIH	High-level input voltage		2		5.5	V
V _{IL}	Low-level input voltage				0.8	V
ІОН	High-level output current				-2	mA
l _{OL}	OL Low-level output current				12	mA
fclock	Clock frequency		0		41.6	MHz
	Pulse duration, clock (see Note 2)	High	10			ns
t _W	ruise duration, clock (see note 2)	Low	11			115
t _{su}	Setup time, input or feedback before clock↑		20			ns
t _h	Hold time, input or feedback after clock↑	0			ns	
TA	Operating free-air temperature	- 55	25	125	°C	

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{Clock}. The minimum pulse durations specified are for clock high or low only, but not for both simultaneously.



TIBPAL 16L8-20M, TIBPAL 16R4-20M, TIBPAL 16R6-20M, TIBPAL 16R8-20M HIGH-PERFORMANCE *IMPACT* ™ *PAL*® CIRCUITS

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electrical characteristics over recommended operating free-air temperature range

P	ARAMETER		TEST CONDITIO	NS	MIN	TYP [†]	MAX	UNIT
VIK		$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$				-1.5	V
Vон		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$		2.4	3.2		V
VOL		$V_{CC} = 4.5 \text{ V},$	I _{OL} = 12 mA			0.25	0.4	V
10711	Outputs	V00 - 5 5 V	Vo - 27V				20	
lozh	I/O ports	V _{CC} = 5.5 V,	$V_0 = 2.7 \text{ V}$				100	μΑ
10.71	Outputs	V00 - 5 5 V	VO = 0.4 V				-20	
IOZL	I/O ports	V _{CC} = 5.5 V,	VO = 0.4 V				-250	μΑ
١.	Pin 1, 11	Vaa 55V	\\.				0.2	mA
11	All others	V _{CC} = 5.5 V,	V _I = 5.5 V				0.1	IIIA
	Pin 1, 11						50	
lін	I/O ports	$V_{CC} = 5.5 V$,	$V_1 = 2.7 \ V$				100	μΑ
	All others]					20	
1	I/O ports	Vaa 55V	V ₂ 0.4 V				-0.25	A
¹IL	All others	V _{CC} = 5.5 V,	V = 0.4 V	V _I = 0.4 V			-0.2	mA
los [‡]		V _{CC} = 5.5 V,	V _O = 0.5 V		-30		-250	mA
ICC	·	$V_{CC} = 5.5 \text{ V},$	$V_{I} = 0$,	Outputs open		140	190	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}				41.6			MHz
t _{pd}	I, I/O	O, I/O			10	20	ns
t _{pd}	CLK↑	Q	R1 = 390 Ω ,		8	15	ns
t _{en}	OE↓	Q	$R2 = 750 \Omega$,		8	15	ns
^t dis	OE↑	Q	See Figure 4		7	15	ns
t _{en}	I, I/O	O, I/O			10	20	ns
^t dis	I, I/O	O, I/O			10	20	ns

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[‡] Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. Set V_O at 0.5 V to avoid test-equipment degradation.

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programming information

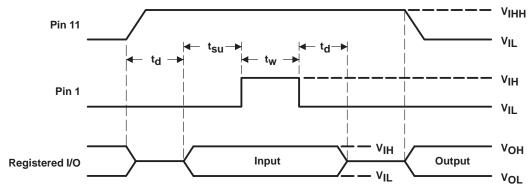
Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic also is available, upon request, from the nearest TI field sales office or local authorized TI distributor, by calling Texas Instruments at +1 (972) 644–5580, or by visiting the TI Semiconductor Home Page at www.ti.com/sc.

preload procedure for registered outputs (see Figure 1 and Note 3)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below.

- Step 1. With V_{CC} at 5 V and Pin 1 at V_{IL} , raise Pin 11 to V_{IHH} .
- Step 2. Apply either V_{IL} or V_{IH} to the output corresponding to the register to be preloaded.
- Step 3. Pulse Pin 1, clocking in preload data.
- Step 4. Remove output voltage, then lower Pin 11 to $V_{\rm IL}$. Preload can be verified by observing the voltage level at the output pin.



NOTE 3: $t_d = t_{SU} = t_h = 100 \text{ ns to } 1000 \text{ ns V}_{IHH} = 10.25 \text{ V to } 10.75 \text{ V}$

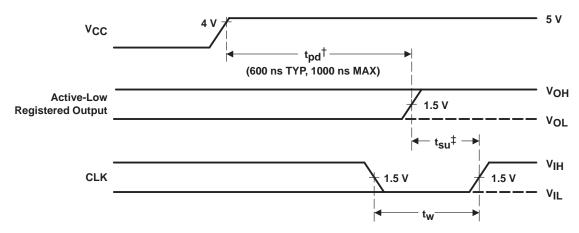
Figure 1. Preload Waveforms

TIBPAL 16L8-15C, TIBPAL 16R4-15C, TIBPAL 16R6-15C, TIBPAL 16R8-15C TIBPAL 16L8-20M, TIBPAL 16R4-20M, TIBPAL 16R8-20M HIGH-PERFORMANCE *IMPACT* ™ *PAL*® CIRCUITS

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power-up reset (see Figure 2)

Following power up, all registers are set high. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of V_{CC} be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.



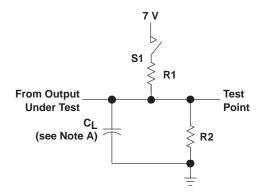
[†] This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data.

Figure 2. Power-Up Reset Waveforms

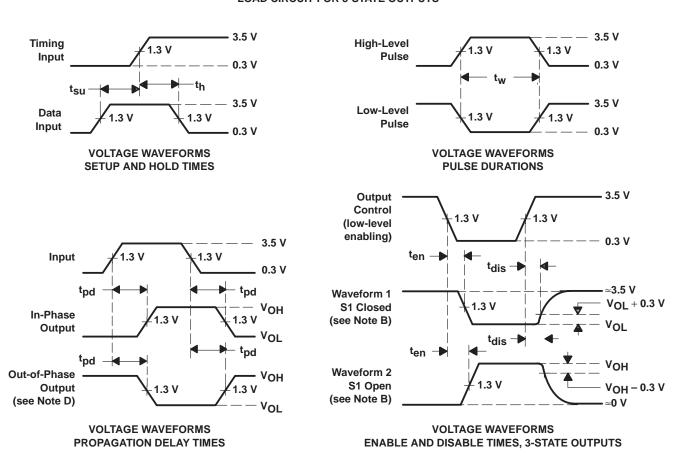


[‡]This is the setup time for input or feedback.

PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT FOR 3-STATE OUTPUTS

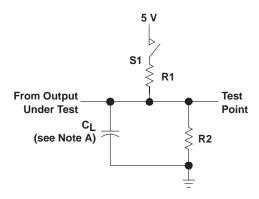


- NOTES: A. C_L includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en} , 5 pF for t_{dis} .
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_T = t_f \leq$ 2 ns, duty cycle = 50%
 - D. When measuring propagation delay times of 3-state outputs from low to high, switch S1 is closed. When measuring propagation delay times of 3-state outputs from high to low, switch S1 is open.
 - E. Equivalent loads may be used for testing.

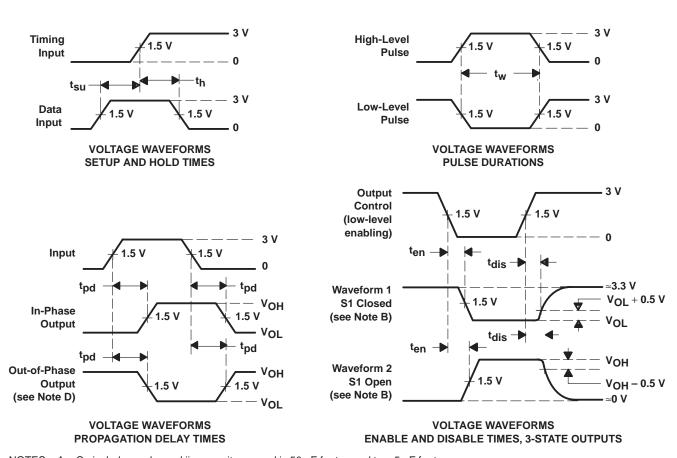
Figure 3. Load Circuit and Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT FOR 3-STATE OUTPUTS



- NOTES: A. C_L includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en} , 5 pF for t_{dis} .
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses have the following characteristics: PRR \leq 10 MHz, $t_f = t_f \leq$ 2 ns, duty cycle = 50%
 - D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
 - E. Equivalent loads may be used for testing.

Figure 4. Load Circuit and Voltage Waveforms









PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
5962-85155012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-8515501RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
5962-8515501SA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
5962-85155022A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-8515502RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
5962-8515502SA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
5962-85155032A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-8515503RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
5962-8515503SA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
5962-85155042A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-8515504RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
5962-8515504SA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
JM38510/50601BRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
JM38510/50602BRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
JM38510/50603BRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
JM38510/50604BRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16L8-15CFN	ACTIVE	PLCC	FN	20	46	TBD	CU SNPB	Level-1-220C-UNLIM
TIBPAL16L8-15CN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TIBPAL16L8-20MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
TIBPAL16L8-20MJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16L8-20MJB	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16L8-20MWB	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16R4-15CFN	ACTIVE	PLCC	FN	20	46	TBD	CU SNPB	Level-1-220C-UNLIM
TIBPAL16R4-15CN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TIBPAL16R4-20MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
TIBPAL16R4-20MJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16R4-20MJB	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16R4-20MWB	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16R6-15CFN	ACTIVE	PLCC	FN	20	46	TBD	CU SNPB	Level-1-220C-UNLIM
TIBPAL16R6-15CN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TIBPAL16R6-20MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
TIBPAL16R6-20MJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16R6-20MJB	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16R6-20MWB	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16R8-15CFN	ACTIVE	PLCC	FN	20	46	TBD	CU SNPB	Level-1-220C-UNLIM
TIBPAL16R8-15CN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TIBPAL16R8-20MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
TIBPAL16R8-20MJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type
TIBPAL16R8-20MJB	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type



PACKAGE OPTION ADDENDUM

24-Sep-2007

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Pack Qt	age Eco Plan ⁽²⁾ /	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TIBPAL16R8-20MWB	ACTIVE	CFP	W	20 1	TBD	A42	N / A for Pkg Type

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



FN (S-PQCC-J**)

20 PIN SHOWN

PLASTIC J-LEADED CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-018



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